+357 96 030922
info@marketpublishers.com

Global CSP Package eMMC Market Growth 2026-2032

https://marketpublishers.com/r/G8F033073353EN.html
Date: October 2026
Pages: 155
Price: US$ 3,660.00 (Single User License)
ID: G8F033073353EN

Abstracts

The global CSP Package eMMC market size is predicted to grow from US$ 11465 million in 2025 to US$ 13897 million in 2032; it is expected to grow at a CAGR of 2.7% from 2026 to 2032.

CSP Package eMMC refers to an embedded non-volatile storage device that integrates NAND flash memory, an eMMC controller, firmware and flash-management functions within a compact chip-scale BGA package. The device connects directly to a host processor through the standardized eMMC interface and internally performs error correction, bad-block management, wear leveling, logical address translation, background operations and other NAND management functions, thereby reducing host-side storage-management complexity. Current commercial products are primarily based on the eMMC 5.1 specification and HS400 transfer mode, with 153-ball BGA/FBGA remaining the mainstream package configuration alongside 100-ball BGA and smaller form-factor packages for space-constrained designs. Product portfolios span multiple storage densities and are commonly differentiated into commercial, industrial and automotive grades according to operating temperature, endurance, NAND configuration, firmware strategy, reliability requirements and product-lifecycle support. CSP Package eMMC is widely used in smartphones and tablets, smart televisions and set-top boxes, networking and surveillance equipment, smart-home devices, industrial and IoT systems, medical electronics and automotive applications where compact size, low power consumption, mature interface compatibility and cost efficiency are important.

Key Findings

eMMC 5.1 remains the mainstream specification for CSP Package eMMC, with 153-ball BGA continuing as the dominant package format

Demand is gradually shifting from premium mobile devices toward automotive,

+357 96 030922
info@marketpublishers.com

industrial, IoT, networking and smart-home applications

Industrial and automotive grades are gaining importance as customers prioritize endurance, wide-temperature operation, stable BOMs and long product lifecycles

Supply remains led by NAND manufacturers, while independent storage suppliers compete through controllers, firmware, packaging, testing and customization

Market Trends

The CSP Package eMMC market is moving from a consumer-electronics-led growth model toward a more diversified embedded-storage structure. High-performance smartphones and premium mobile devices continue to migrate toward UFS, reducing the strategic importance of eMMC in applications where interface bandwidth is a primary requirement. At the same time, eMMC 5.1 remains deeply embedded in mature processor platforms used in smart televisions, set-top boxes, networking equipment, surveillance systems, industrial controllers, IoT terminals and automotive electronics. Product development is increasingly focused on reliability rather than interface-speed expansion, including wider operating-temperature ranges, improved endurance, health monitoring, optimized firmware, fixed-BOM programs and longer lifecycle support. Standard 153-ball packages continue to represent the mainstream configuration, while compact BGA designs are gaining relevance in space-constrained embedded products. The long-term direction of the market is therefore characterized by declining dependence on premium consumer electronics and increasing concentration on cost-sensitive, long-lifecycle and high-reliability applications.

Market Dynamics

Drivers

Demand for CSP Package eMMC is supported by the large installed base of processors and embedded platforms designed around the mature eMMC interface. Compared with higher-performance embedded-storage architectures, eMMC offers lower implementation complexity, established software compatibility, compact PCB design and competitive system cost. These characteristics remain important in smart-home products, networking equipment, surveillance devices, industrial control systems, IoT terminals and selected automotive electronics, where storage performance requirements are moderate but reliability, power consumption and lifecycle stability are critical.

+357 96 030922
info@marketpublishers.com

Restraints

The main structural restraint is the continued substitution of eMMC by UFS in performance-sensitive applications. As application processors support faster storage interfaces and software workloads become more data intensive, high-end smartphones, advanced tablets and selected automotive computing platforms increasingly prefer UFS. The mature nature of eMMC also limits opportunities for major interface-level differentiation, while NAND price cycles can compress margins for independent suppliers that rely on externally sourced flash memory.

Opportunities

The strongest opportunities are emerging in industrial, automotive and long-lifecycle embedded applications where customers increasingly require wide-temperature operation, controlled firmware, stable component configurations and extended supply commitments. Additional opportunities exist in compact eMMC packages for small embedded devices, localized supply chains in China and other Asian manufacturing markets, and customized managed-NAND products designed for industrial controllers, gateways, cameras, edge devices and specialized electronics. These segments provide greater scope for differentiation than standardized consumer-grade products.

Challenges

Suppliers must manage simultaneous pressure from NAND supply volatility, product qualification requirements and technology substitution. Industrial and automotive customers typically require longer validation cycles and stronger reliability guarantees, increasing engineering and inventory commitments. Independent storage suppliers also need sustained capabilities in controller design, firmware optimization, NAND qualification, packaging and failure analysis to compete effectively. As basic consumer-grade eMMC becomes increasingly standardized, maintaining differentiation without excessive cost becomes a central challenge for smaller suppliers.

Industry Chain Analysis

The upstream CSP Package eMMC industry chain consists primarily of NAND flash wafers and dies, storage controllers, firmware technologies, packaging substrates and related semiconductor materials. NAND represents the largest underlying hardware cost and has a major influence on product pricing and profitability because flash-memory pricing follows cyclical supply-demand conditions. Controller architecture and firmware determine important managed-storage capabilities such as error correction, wear

+357 96 030922
info@marketpublishers.com

leveling, bad-block management, performance consistency, data retention and device-health management. Packaging and testing provide the physical integration required to combine NAND, controller and associated components into compact BGA-based devices.

The midstream segment integrates NAND resources, controller technology, firmware, packaging and testing into qualified eMMC products and is divided between vertically integrated NAND manufacturers and independent embedded-storage suppliers. The downstream market consists of consumer-electronics manufacturers, networking and surveillance equipment vendors, industrial automation companies, IoT device manufacturers, medical-electronics suppliers and automotive electronics companies. Value creation is increasingly shifting from basic storage capacity toward NAND supply security, firmware reliability, lifecycle management, qualification support and application-specific customization, particularly in industrial and automotive applications.

Segment Insights

By capacity, the current CSP Package eMMC market is concentrated around mainstream embedded-storage densities spanning approximately 16GB to 128GB, while lower-capacity products continue to serve cost-sensitive and legacy embedded platforms and higher-capacity products address selected applications requiring greater local storage. By package configuration, standard 153-ball BGA/FBGA remains the principal commercial format because of its mature ecosystem and broad processor compatibility, while 100-ball and compact BGA packages address designs with tighter PCB-space constraints.

By product grade, commercial-grade products continue to account for the broadest range of volume applications, while industrial-grade and automotive-grade products are becoming increasingly important from a value perspective. These higher-reliability segments require wider operating-temperature ranges, stronger endurance, controlled firmware and longer product lifecycles. By application, smartphones and tablets remain an established demand base, but the more attractive structural opportunities are increasingly found in smart televisions and set-top boxes, networking and surveillance, industrial and IoT equipment and automotive electronics.

Downstream Market Opportunities

Downstream opportunities are increasingly concentrated in applications where customers value stable platforms and lifecycle support more than maximum storage-

+357 96 030922
info@marketpublishers.com

interface performance. Smart televisions, set-top boxes, routers, gateways and surveillance devices continue to provide a broad demand base because eMMC offers sufficient performance at competitive system cost. Industrial automation, IoT edge devices and automotive electronics provide stronger opportunities for product differentiation, as these applications place greater emphasis on endurance, temperature tolerance, data integrity and long-term availability. Automotive clusters, infotainment systems, telematics units and embedded control devices are particularly relevant for suppliers capable of meeting stricter reliability and qualification requirements.

Regional Insights

Asia-Pacific represents the center of the global CSP Package eMMC supply chain, supported by the concentration of NAND manufacturing, semiconductor packaging, storage-controller development and electronics production in South Korea, Japan, China and Taiwan. The region also represents the principal production base for many downstream consumer, industrial and automotive electronics products. China has become one of the most active markets for embedded-storage localization, with domestic suppliers expanding capabilities in controller development, firmware, packaging, testing and product qualification rather than competing only through low-cost assembly.

North America remains important through major semiconductor and embedded-storage suppliers as well as demand from industrial, networking, automotive and technology customers. Europe represents a smaller volume market but has greater relative importance in industrial and automotive applications, where local supply, reliability, product longevity and qualification support are valued. Japan and South Korea retain significant influence through their established NAND technology and semiconductor manufacturing capabilities, while Taiwan maintains a broad ecosystem of storage-controller and industrial-storage suppliers.

Competitive Landscape Analysis

The CSP Package eMMC market has a two-layer competitive structure. Global NAND manufacturers occupy the leading position through advantages in flash-memory technology, wafer supply, manufacturing scale, cost control and global customer qualification, while independent embedded-storage suppliers compete through controller integration, firmware optimization, NAND sourcing, packaging and testing, industrial-grade design and customer-specific support. Competition in mainstream consumer-grade eMMC is relatively standardized and increasingly cost driven, whereas

+357 96 030922
info@marketpublishers.com

industrial and automotive segments provide greater room for differentiation through endurance, wide-temperature capability, fixed-BOM strategies, health monitoring, lifecycle management and long-term supply commitments. Chinese suppliers are expanding from conventional packaging and module-oriented activities toward controller, firmware and integrated storage-product development, gradually strengthening local supply capabilities. Over the longer term, competitive intensity is expected to shift away from interface-speed competition and toward supply reliability, firmware capability, application qualification and lifecycle services as UFS continues to absorb performance-oriented applications while eMMC remains concentrated in mature, cost-sensitive and high-reliability embedded platforms.

Report Scope

LP Information, Inc. (LPI) ' newest research report, the “CSP Package eMMC Industry Forecast” looks at past sales and reviews total world CSP Package eMMC sales in 2025, providing a comprehensive analysis by region and market sector of projected CSP Package eMMC sales for 2026 through 2032. With CSP Package eMMC sales broken down by region, market sector and sub-sector, this report provides a detailed analysis in US$ millions of the world CSP Package eMMC industry.

This Insight Report provides a comprehensive analysis of the global CSP Package eMMC landscape and highlights key trends related to product segmentation, company formation, revenue, and market share, latest development, and M&A activity. This report also analyzes the strategies of leading global companies with a focus on CSP Package eMMC portfolios and capabilities, market entry strategies, market positions, and geographic footprints, to better understand these firms’ unique position in an accelerating global CSP Package eMMC market.

This Insight Report evaluates the key market trends, drivers, and affecting factors shaping the global outlook for CSP Package eMMC and breaks down the forecast by Type, by Application, geography, and market size to highlight emerging pockets of opportunity. With a transparent methodology based on hundreds of bottom-up qualitative and quantitative market inputs, this study forecast offers a highly nuanced view of the current state and future trajectory in the global CSP Package eMMC.

This report presents a comprehensive overview, market shares, and growth opportunities of CSP Package eMMC market by product type, application, key manufacturers and key regions and countries.

+357 96 030922
info@marketpublishers.com

Market Segmentation

Segmentation by Type:

8GB and Below

16GB

32GB

64GB

128GB

256GB and Above

Segmentation by Package Configuration:

Standard 153-ball BGA

Compact BGA

100-ball BGA

Other

Segmentation by Product Grade:

Commercial Grade

Industrial Grade

Automotive Grade

Segmentation by Application:

+357 96 030922
info@marketpublishers.com

Smartphones & Tablets

Smart TV & Set-top Boxes

Networking & Surveillance

Industrial & IoT

Automotive Electronics

Other

This report also splits the market by region:

Americas

United States

Canada

Mexico

Brazil

APAC

China

Japan

Korea

Southeast Asia

India

Australia

+357 96 030922
info@marketpublishers.com

- Europe
  - Germany
  - France
  - UK
  - Italy
  - Russia
- Middle East & Africa
  - Egypt
  - South Africa
  - Israel
  - Turkey
  - GCC Countries

The below companies that are profiled have been selected based on inputs gathered from primary experts and analysing the company's coverage, product portfolio, its market penetration.

- Samsung Electronics
- SK hynix
- Kioxia
- Sandisk
- Micron Technology

+357 96 030922
info@marketpublishers.com

Yangtze Memory Technologies

Longsys

Kingston Technology

Silicon Motion

Macronix

BIWIN

Rayson

HIKSEMI

ADATA Technology

Apacer Technology

Transcend Information

ATP Electronics

Greenliant

Swissbit

HOSIN Global Electronics

SCY

KOWIN Technology

Key Questions Addressed in this Report

+357 96 030922
info@marketpublishers.com

What is the 10-year outlook for the global CSP Package eMMC market?

What factors are driving CSP Package eMMC market growth, globally and by region?

Which technologies are poised for the fastest growth by market and region?

How do CSP Package eMMC market opportunities vary by end market size?

How does CSP Package eMMC break out by Type, by Application?

+357 96 030922
info@marketpublishers.com

Contents

1 SCOPE OF THE REPORT

1.1 Market Introduction
1.2 Years Considered
1.3 Research Objectives
1.4 Market Research Methodology
1.5 Research Process and Data Source
1.6 Economic Indicators
1.7 Currency Considered
1.8 Market Estimation Caveats

2 EXECUTIVE SUMMARY

2.1 World Market Overview
  2.1.1 Global CSP Package eMMC Annual Sales 2021-2032
  2.1.2 World Current & Future Analysis for CSP Package eMMC by Geographic Region, 2021, 2025 & 2032
  2.1.3 World Current & Future Analysis for CSP Package eMMC by Country/Region, 2021, 2025 & 2032
2.2 CSP Package eMMC Segment by Type
  2.2.1 8GB and Below
  2.2.2 16GB
  2.2.3 32GB
  2.2.4 64GB
  2.2.5 128GB
  2.2.6 256GB and Above
  2.2.7 CSP Package eMMC Sales by Type
    2.2.7.1 Global CSP Package eMMC Sales Market Share by Type (2021-2026)
    2.2.7.2 Global CSP Package eMMC Revenue and Market Share by Type (2021-2026)
    2.2.7.3 Global CSP Package eMMC Sale Price by Type (2021-2026)
2.3 CSP Package eMMC Segment by Package Configuration
  2.3.1 Standard 153-ball BGA
  2.3.2 Compact BGA
  2.3.3 100-ball BGA
  2.3.4 Other
  2.3.5 CSP Package eMMC Sales by Package Configuration

+357 96 030922
info@marketpublishers.com

2.3.5.1 Global CSP Package eMMC Sales Market Share by Package Configuration (2021-2026)
2.3.5.2 Global CSP Package eMMC Revenue and Market Share by Package Configuration (2021-2026)
2.3.5.3 Global CSP Package eMMC Sale Price by Package Configuration (2021-2026)
2.4 CSP Package eMMC Segment by Product Grade
2.4.1 Commercial Grade
2.4.2 Industrial Grade
2.4.3 Automotive Grade
2.4.4 CSP Package eMMC Sales by Product Grade
2.4.4.1 Global CSP Package eMMC Sales Market Share by Product Grade (2021-2026)
2.4.4.2 Global CSP Package eMMC Revenue and Market Share by Product Grade (2021-2026)
2.4.4.3 Global CSP Package eMMC Sale Price by Product Grade (2021-2026)
2.5 CSP Package eMMC Segment by Application
2.5.1 Smartphones & Tablets
2.5.2 Smart TV & Set-top Boxes
2.5.3 Networking & Surveillance
2.5.4 Industrial & IoT
2.5.5 Automotive Electronics
2.5.6 Other
2.5.7 CSP Package eMMC Sales by Application
2.5.7.1 Global CSP Package eMMC Sale Market Share by Application (2021-2026)
2.5.7.2 Global CSP Package eMMC Revenue and Market Share by Application (2021-2026)
2.5.7.3 Global CSP Package eMMC Sale Price by Application (2021-2026)

3 GLOBAL BY COMPANY

3.1 Global CSP Package eMMC Breakdown Data by Company
3.1.1 Global CSP Package eMMC Annual Sales by Company (2021-2026)
3.1.2 Global CSP Package eMMC Sales Market Share by Company (2021-2026)
3.2 Global CSP Package eMMC Annual Revenue by Company (2021-2026)
3.2.1 Global CSP Package eMMC Revenue by Company (2021-2026)
3.2.2 Global CSP Package eMMC Revenue Market Share by Company (2021-2026)
3.3 Global CSP Package eMMC Sale Price by Company
3.4 Key Manufacturers CSP Package eMMC Producing Area Distribution, Sales Area,

+357 96 030922
info@marketpublishers.com

Product Type
3.4.1 Key Manufacturers CSP Package eMMC Product Location Distribution
3.4.2 Players CSP Package eMMC Products Offered
3.5 Market Concentration Rate Analysis
3.5.1 Competition Landscape Analysis
3.5.2 Concentration Ratio (CR3, CR5 and CR10) & (2024-2026)
3.6 New Products and Potential Entrants
3.7 Market M&A Activity & Strategy

4 WORLD HISTORIC REVIEW FOR CSP PACKAGE EMMC BY GEOGRAPHIC REGION

4.1 World Historic CSP Package eMMC Market Size by Geographic Region (2021-2026)
4.1.1 Global CSP Package eMMC Annual Sales by Geographic Region (2021-2026)
4.1.2 Global CSP Package eMMC Annual Revenue by Geographic Region (2021-2026)
4.2 World Historic CSP Package eMMC Market Size by Country/Region (2021-2026)
4.2.1 Global CSP Package eMMC Annual Sales by Country/Region (2021-2026)
4.2.2 Global CSP Package eMMC Annual Revenue by Country/Region (2021-2026)
4.3 Americas CSP Package eMMC Sales Growth
4.4 APAC CSP Package eMMC Sales Growth
4.5 Europe CSP Package eMMC Sales Growth
4.6 Middle East & Africa CSP Package eMMC Sales Growth

5 AMERICAS

5.1 Americas CSP Package eMMC Sales by Country
5.1.1 Americas CSP Package eMMC Sales by Country (2021-2026)
5.1.2 Americas CSP Package eMMC Revenue by Country (2021-2026)
5.2 Americas CSP Package eMMC Sales by Type (2021-2026)
5.3 Americas CSP Package eMMC Sales by Application (2021-2026)
5.4 United States
5.5 Canada
5.6 Mexico
5.7 Brazil

6 APAC

+357 96 030922
info@marketpublishers.com

6.1 APAC CSP Package eMMC Sales by Region
6.1.1 APAC CSP Package eMMC Sales by Region (2021-2026)
6.1.2 APAC CSP Package eMMC Revenue by Region (2021-2026)
6.2 APAC CSP Package eMMC Sales by Type (2021-2026)
6.3 APAC CSP Package eMMC Sales by Application (2021-2026)
6.4 China
6.5 Japan
6.6 South Korea
6.7 Southeast Asia
6.8 India
6.9 Australia
6.10 China Taiwan

7 EUROPE

7.1 Europe CSP Package eMMC by Country
7.1.1 Europe CSP Package eMMC Sales by Country (2021-2026)
7.1.2 Europe CSP Package eMMC Revenue by Country (2021-2026)
7.2 Europe CSP Package eMMC Sales by Type (2021-2026)
7.3 Europe CSP Package eMMC Sales by Application (2021-2026)
7.4 Germany
7.5 France
7.6 UK
7.7 Italy
7.8 Russia

8 MIDDLE EAST & AFRICA

8.1 Middle East & Africa CSP Package eMMC by Country
8.1.1 Middle East & Africa CSP Package eMMC Sales by Country (2021-2026)
8.1.2 Middle East & Africa CSP Package eMMC Revenue by Country (2021-2026)
8.2 Middle East & Africa CSP Package eMMC Sales by Type (2021-2026)
8.3 Middle East & Africa CSP Package eMMC Sales by Application (2021-2026)
8.4 Egypt
8.5 South Africa
8.6 Israel
8.7 Turkey
8.8 GCC Countries

+357 96 030922
info@marketpublishers.com

9 MARKET DRIVERS, CHALLENGES AND TRENDS

9.1 Market Drivers & Growth Opportunities
9.2 Market Challenges & Risks
9.3 Industry Trends

10 MANUFACTURING COST STRUCTURE ANALYSIS

10.1 Raw Material and Suppliers
10.2 Manufacturing Cost Structure Analysis of CSP Package eMMC
10.3 Manufacturing Process Analysis of CSP Package eMMC
10.4 Industry Chain Structure of CSP Package eMMC

11 MARKETING, DISTRIBUTORS AND CUSTOMER

11.1 Sales Channel
  11.1.1 Direct Channels
  11.1.2 Indirect Channels
11.2 CSP Package eMMC Distributors
11.3 CSP Package eMMC Customer

12 WORLD FORECAST REVIEW FOR CSP PACKAGE EMMC BY GEOGRAPHIC REGION

12.1 Global CSP Package eMMC Market Size Forecast by Region
  12.1.1 Global CSP Package eMMC Forecast by Region (2027-2032)
  12.1.2 Global CSP Package eMMC Annual Revenue Forecast by Region (2027-2032)
12.2 Americas Forecast by Country (2027-2032)
12.3 APAC Forecast by Region (2027-2032)
12.4 Europe Forecast by Country (2027-2032)
12.5 Middle East & Africa Forecast by Country (2027-2032)
12.6 Global CSP Package eMMC Forecast by Type (2027-2032)
12.7 Global CSP Package eMMC Forecast by Application (2027-2032)

13 KEY PLAYERS ANALYSIS

13.1 Samsung Electronics
  13.1.1 Samsung Electronics Company Information
  13.1.2 Samsung Electronics CSP Package eMMC Product Portfolios and

+357 96 030922
info@marketpublishers.com

Specifications
13.1.3 Samsung Electronics CSP Package eMMC Sales, Revenue, Price and Gross Margin (2021-2026)
13.1.4 Samsung Electronics Main Business Overview
13.1.5 Samsung Electronics Latest Developments
13.2 SK hynix
13.2.1 SK hynix Company Information
13.2.2 SK hynix CSP Package eMMC Product Portfolios and Specifications
13.2.3 SK hynix CSP Package eMMC Sales, Revenue, Price and Gross Margin (2021-2026)
13.2.4 SK hynix Main Business Overview
13.2.5 SK hynix Latest Developments
13.3 Kioxia
13.3.1 Kioxia Company Information
13.3.2 Kioxia CSP Package eMMC Product Portfolios and Specifications
13.3.3 Kioxia CSP Package eMMC Sales, Revenue, Price and Gross Margin (2021-2026)
13.3.4 Kioxia Main Business Overview
13.3.5 Kioxia Latest Developments
13.4 Sandisk
13.4.1 Sandisk Company Information
13.4.2 Sandisk CSP Package eMMC Product Portfolios and Specifications
13.4.3 Sandisk CSP Package eMMC Sales, Revenue, Price and Gross Margin (2021-2026)
13.4.4 Sandisk Main Business Overview
13.4.5 Sandisk Latest Developments
13.5 Micron Technology
13.5.1 Micron Technology Company Information
13.5.2 Micron Technology CSP Package eMMC Product Portfolios and Specifications
13.5.3 Micron Technology CSP Package eMMC Sales, Revenue, Price and Gross Margin (2021-2026)
13.5.4 Micron Technology Main Business Overview
13.5.5 Micron Technology Latest Developments
13.6 Yangtze Memory Technologies
13.6.1 Yangtze Memory Technologies Company Information
13.6.2 Yangtze Memory Technologies CSP Package eMMC Product Portfolios and Specifications
13.6.3 Yangtze Memory Technologies CSP Package eMMC Sales, Revenue, Price and Gross Margin (2021-2026)

+357 96 030922
info@marketpublishers.com

13.6.4 Yangtze Memory Technologies Main Business Overview
13.6.5 Yangtze Memory Technologies Latest Developments
13.7 Longsys
13.7.1 Longsys Company Information
13.7.2 Longsys CSP Package eMMC Product Portfolios and Specifications
13.7.3 Longsys CSP Package eMMC Sales, Revenue, Price and Gross Margin (2021-2026)
13.7.4 Longsys Main Business Overview
13.7.5 Longsys Latest Developments
13.8 Kingston Technology
13.8.1 Kingston Technology Company Information
13.8.2 Kingston Technology CSP Package eMMC Product Portfolios and Specifications
13.8.3 Kingston Technology CSP Package eMMC Sales, Revenue, Price and Gross Margin (2021-2026)
13.8.4 Kingston Technology Main Business Overview
13.8.5 Kingston Technology Latest Developments
13.9 Silicon Motion
13.9.1 Silicon Motion Company Information
13.9.2 Silicon Motion CSP Package eMMC Product Portfolios and Specifications
13.9.3 Silicon Motion CSP Package eMMC Sales, Revenue, Price and Gross Margin (2021-2026)
13.9.4 Silicon Motion Main Business Overview
13.9.5 Silicon Motion Latest Developments
13.10 Macronix
13.10.1 Macronix Company Information
13.10.2 Macronix CSP Package eMMC Product Portfolios and Specifications
13.10.3 Macronix CSP Package eMMC Sales, Revenue, Price and Gross Margin (2021-2026)
13.10.4 Macronix Main Business Overview
13.10.5 Macronix Latest Developments
13.11 BIWIN
13.11.1 BIWIN Company Information
13.11.2 BIWIN CSP Package eMMC Product Portfolios and Specifications
13.11.3 BIWIN CSP Package eMMC Sales, Revenue, Price and Gross Margin (2021-2026)
13.11.4 BIWIN Main Business Overview
13.11.5 BIWIN Latest Developments
13.12 Rayson

+357 96 030922
info@marketpublishers.com

13.12.1 Rayson Company Information
13.12.2 Rayson CSP Package eMMC Product Portfolios and Specifications
13.12.3 Rayson CSP Package eMMC Sales, Revenue, Price and Gross Margin (2021-2026)
13.12.4 Rayson Main Business Overview
13.12.5 Rayson Latest Developments
13.13 HIKSEMI
13.13.1 HIKSEMI Company Information
13.13.2 HIKSEMI CSP Package eMMC Product Portfolios and Specifications
13.13.3 HIKSEMI CSP Package eMMC Sales, Revenue, Price and Gross Margin (2021-2026)
13.13.4 HIKSEMI Main Business Overview
13.13.5 HIKSEMI Latest Developments
13.14 ADATA Technology
13.14.1 ADATA Technology Company Information
13.14.2 ADATA Technology CSP Package eMMC Product Portfolios and Specifications
13.14.3 ADATA Technology CSP Package eMMC Sales, Revenue, Price and Gross Margin (2021-2026)
13.14.4 ADATA Technology Main Business Overview
13.14.5 ADATA Technology Latest Developments
13.15 Apacer Technology
13.15.1 Apacer Technology Company Information
13.15.2 Apacer Technology CSP Package eMMC Product Portfolios and Specifications
13.15.3 Apacer Technology CSP Package eMMC Sales, Revenue, Price and Gross Margin (2021-2026)
13.15.4 Apacer Technology Main Business Overview
13.15.5 Apacer Technology Latest Developments
13.16 Transcend Information
13.16.1 Transcend Information Company Information
13.16.2 Transcend Information CSP Package eMMC Product Portfolios and Specifications
13.16.3 Transcend Information CSP Package eMMC Sales, Revenue, Price and Gross Margin (2021-2026)
13.16.4 Transcend Information Main Business Overview
13.16.5 Transcend Information Latest Developments
13.17 ATP Electronics
13.17.1 ATP Electronics Company Information

+357 96 030922
info@marketpublishers.com

13.17.2 ATP Electronics CSP Package eMMC Product Portfolios and Specifications
13.17.3 ATP Electronics CSP Package eMMC Sales, Revenue, Price and Gross Margin (2021-2026)
13.17.4 ATP Electronics Main Business Overview
13.17.5 ATP Electronics Latest Developments
13.18 Greenliant
13.18.1 Greenliant Company Information
13.18.2 Greenliant CSP Package eMMC Product Portfolios and Specifications
13.18.3 Greenliant CSP Package eMMC Sales, Revenue, Price and Gross Margin (2021-2026)
13.18.4 Greenliant Main Business Overview
13.18.5 Greenliant Latest Developments
13.19 Swissbit
13.19.1 Swissbit Company Information
13.19.2 Swissbit CSP Package eMMC Product Portfolios and Specifications
13.19.3 Swissbit CSP Package eMMC Sales, Revenue, Price and Gross Margin (2021-2026)
13.19.4 Swissbit Main Business Overview
13.19.5 Swissbit Latest Developments
13.20 HOSIN Global Electronics
13.20.1 HOSIN Global Electronics Company Information
13.20.2 HOSIN Global Electronics CSP Package eMMC Product Portfolios and Specifications
13.20.3 HOSIN Global Electronics CSP Package eMMC Sales, Revenue, Price and Gross Margin (2021-2026)
13.20.4 HOSIN Global Electronics Main Business Overview
13.20.5 HOSIN Global Electronics Latest Developments
13.21 SCY
13.21.1 SCY Company Information
13.21.2 SCY CSP Package eMMC Product Portfolios and Specifications
13.21.3 SCY CSP Package eMMC Sales, Revenue, Price and Gross Margin (2021-2026)
13.21.4 SCY Main Business Overview
13.21.5 SCY Latest Developments
13.22 KOWIN Technology
13.22.1 KOWIN Technology Company Information
13.22.2 KOWIN Technology CSP Package eMMC Product Portfolios and Specifications
13.22.3 KOWIN Technology CSP Package eMMC Sales, Revenue, Price and Gross

+357 96 030922
info@marketpublishers.com

Margin (2021-2026)
13.22.4 KOWIN Technology Main Business Overview
13.22.5 KOWIN Technology Latest Developments

14 RESEARCH FINDINGS AND CONCLUSION

+357 96 030922
info@marketpublishers.com

List Of Tables

LIST OF TABLES

Table 1. CSP Package eMMC Annual Sales CAGR by Geographic Region (2021, 2025 & 2032) & ($ millions)
Table 2. CSP Package eMMC Annual Sales CAGR by Country/Region (2021, 2025 & 2032) & ($ millions)
Table 3. Major Players of 8GB and Below
Table 4. Major Players of 16GB
Table 5. Major Players of 32GB
Table 6. Major Players of 64GB
Table 7. Major Players of 128GB
Table 8. Major Players of 256GB and Above
Table 9. Global CSP Package eMMC Sales by Type (2021-2026) & (Million Units)
Table 10. Global CSP Package eMMC Sales Market Share by Type (2021-2026)
Table 11. Global CSP Package eMMC Revenue by Type (2021-2026) & ($ million)
Table 12. Global CSP Package eMMC Revenue Market Share by Type (2021-2026)
Table 13. Global CSP Package eMMC Sale Price by Type (2021-2026) & (US$/Unit)
Table 14. Major Players of Standard 153-ball BGA
Table 15. Major Players of Compact BGA
Table 16. Major Players of 100-ball BGA
Table 17. Major Players of Other
Table 18. Global CSP Package eMMC Sales by Package Configuration (2021-2026) & (Million Units)
Table 19. Global CSP Package eMMC Sales Market Share by Package Configuration (2021-2026)
Table 20. Global CSP Package eMMC Revenue by Package Configuration (2021-2026) & ($ million)
Table 21. Global CSP Package eMMC Revenue Market Share by Package Configuration (2021-2026)
Table 22. Global CSP Package eMMC Sale Price by Package Configuration (2021-2026) & (US$/Unit)
Table 23. Major Players of Commercial Grade
Table 24. Major Players of Industrial Grade
Table 25. Major Players of Automotive Grade
Table 26. Global CSP Package eMMC Sales by Product Grade (2021-2026) & (Million Units)
Table 27. Global CSP Package eMMC Sales Market Share by Product Grade

+357 96 030922
info@marketpublishers.com

(2021-2026)
Table 28. Global CSP Package eMMC Revenue by Product Grade (2021-2026) & ($ million)
Table 29. Global CSP Package eMMC Revenue Market Share by Product Grade (2021-2026)
Table 30. Global CSP Package eMMC Sale Price by Product Grade (2021-2026) & (US$/Unit)
Table 31. Global CSP Package eMMC Sale by Application (2021-2026) & (Million Units)
Table 32. Global CSP Package eMMC Sale Market Share by Application (2021-2026)
Table 33. Global CSP Package eMMC Revenue by Application (2021-2026) & ($ million)
Table 34. Global CSP Package eMMC Revenue Market Share by Application (2021-2026)
Table 35. Global CSP Package eMMC Sale Price by Application (2021-2026) & (US$/Unit)
Table 36. Global CSP Package eMMC Sales by Company (2021-2026) & (Million Units)
Table 37. Global CSP Package eMMC Sales Market Share by Company (2021-2026)
Table 38. Global CSP Package eMMC Revenue by Company (2021-2026) & ($ millions)
Table 39. Global CSP Package eMMC Revenue Market Share by Company (2021-2026)
Table 40. Global CSP Package eMMC Sale Price by Company (2021-2026) & (US$/Unit)
Table 41. Key Manufacturers CSP Package eMMC Producing Area Distribution and Sales Area
Table 42. Players CSP Package eMMC Products Offered
Table 43. CSP Package eMMC Concentration Ratio (CR3, CR5 and CR10) & (2024-2026)
Table 44. New Products and Potential Entrants
Table 45. Market M&A Activity & Strategy
Table 46. Global CSP Package eMMC Sales by Geographic Region (2021-2026) & (Million Units)
Table 47. Global CSP Package eMMC Sales Market Share Geographic Region (2021-2026)
Table 48. Global CSP Package eMMC Revenue by Geographic Region (2021-2026) & ($ millions)
Table 49. Global CSP Package eMMC Revenue Market Share by Geographic Region (2021-2026)
Table 50. Global CSP Package eMMC Sales by Country/Region (2021-2026) & (Million

+357 96 030922
info@marketpublishers.com

Units)
Table 51. Global CSP Package eMMC Sales Market Share by Country/Region (2021-2026)
Table 52. Global CSP Package eMMC Revenue by Country/Region (2021-2026) & ($ millions)
Table 53. Global CSP Package eMMC Revenue Market Share by Country/Region (2021-2026)
Table 54. Americas CSP Package eMMC Sales by Country (2021-2026) & (Million Units)
Table 55. Americas CSP Package eMMC Sales Market Share by Country (2021-2026)
Table 56. Americas CSP Package eMMC Revenue by Country (2021-2026) & ($ millions)
Table 57. Americas CSP Package eMMC Sales by Type (2021-2026) & (Million Units)
Table 58. Americas CSP Package eMMC Sales by Application (2021-2026) & (Million Units)
Table 59. APAC CSP Package eMMC Sales by Region (2021-2026) & (Million Units)
Table 60. APAC CSP Package eMMC Sales Market Share by Region (2021-2026)
Table 61. APAC CSP Package eMMC Revenue by Region (2021-2026) & ($ millions)
Table 62. APAC CSP Package eMMC Sales by Type (2021-2026) & (Million Units)
Table 63. APAC CSP Package eMMC Sales by Application (2021-2026) & (Million Units)
Table 64. Europe CSP Package eMMC Sales by Country (2021-2026) & (Million Units)
Table 65. Europe CSP Package eMMC Revenue by Country (2021-2026) & ($ millions)
Table 66. Europe CSP Package eMMC Sales by Type (2021-2026) & (Million Units)
Table 67. Europe CSP Package eMMC Sales by Application (2021-2026) & (Million Units)
Table 68. Middle East & Africa CSP Package eMMC Sales by Country (2021-2026) & (Million Units)
Table 69. Middle East & Africa CSP Package eMMC Revenue Market Share by Country (2021-2026)
Table 70. Middle East & Africa CSP Package eMMC Sales by Type (2021-2026) & (Million Units)
Table 71. Middle East & Africa CSP Package eMMC Sales by Application (2021-2026) & (Million Units)
Table 72. Key Market Drivers & Growth Opportunities of CSP Package eMMC
Table 73. Key Market Challenges & Risks of CSP Package eMMC
Table 74. Key Industry Trends of CSP Package eMMC
Table 75. CSP Package eMMC Raw Material
Table 76. Key Suppliers of Raw Materials

+357 96 030922
info@marketpublishers.com

Table 77. CSP Package eMMC Distributors List
Table 78. CSP Package eMMC Customer List
Table 79. Global CSP Package eMMC Sales Forecast by Region (2027-2032) & (Million Units)
Table 80. Global CSP Package eMMC Revenue Forecast by Region (2027-2032) & ($ millions)
Table 81. Americas CSP Package eMMC Sales Forecast by Country (2027-2032) & (Million Units)
Table 82. Americas CSP Package eMMC Annual Revenue Forecast by Country (2027-2032) & ($ millions)
Table 83. APAC CSP Package eMMC Sales Forecast by Region (2027-2032) & (Million Units)
Table 84. APAC CSP Package eMMC Annual Revenue Forecast by Region (2027-2032) & ($ millions)
Table 85. Europe CSP Package eMMC Sales Forecast by Country (2027-2032) & (Million Units)
Table 86. Europe CSP Package eMMC Revenue Forecast by Country (2027-2032) & ($ millions)
Table 87. Middle East & Africa CSP Package eMMC Sales Forecast by Country (2027-2032) & (Million Units)
Table 88. Middle East & Africa CSP Package eMMC Revenue Forecast by Country (2027-2032) & ($ millions)
Table 89. Global CSP Package eMMC Sales Forecast by Type (2027-2032) & (Million Units)
Table 90. Global CSP Package eMMC Revenue Forecast by Type (2027-2032) & ($ millions)
Table 91. Global CSP Package eMMC Sales Forecast by Application (2027-2032) & (Million Units)
Table 92. Global CSP Package eMMC Revenue Forecast by Application (2027-2032) & ($ millions)
Table 93. Samsung Electronics Basic Information, CSP Package eMMC Manufacturing Base, Sales Area and Its Competitors
Table 94. Samsung Electronics CSP Package eMMC Product Portfolios and Specifications
Table 95. Samsung Electronics CSP Package eMMC Sales (Million Units), Revenue ($ Million), Price (US$/Unit) and Gross Margin (2021-2026)
Table 96. Samsung Electronics Main Business
Table 97. Samsung Electronics Latest Developments
Table 98. SK hynix Basic Information, CSP Package eMMC Manufacturing Base, Sales

+357 96 030922
info@marketpublishers.com

Area and Its Competitors
Table 99. SK hynix CSP Package eMMC Product Portfolios and Specifications
Table 100. SK hynix CSP Package eMMC Sales (Million Units), Revenue ($ Million), Price (US$/Unit) and Gross Margin (2021-2026)
Table 101. SK hynix Main Business
Table 102. SK hynix Latest Developments
Table 103. Kioxia Basic Information, CSP Package eMMC Manufacturing Base, Sales Area and Its Competitors
Table 104. Kioxia CSP Package eMMC Product Portfolios and Specifications
Table 105. Kioxia CSP Package eMMC Sales (Million Units), Revenue ($ Million), Price (US$/Unit) and Gross Margin (2021-2026)
Table 106. Kioxia Main Business
Table 107. Kioxia Latest Developments
Table 108. Sandisk Basic Information, CSP Package eMMC Manufacturing Base, Sales Area and Its Competitors
Table 109. Sandisk CSP Package eMMC Product Portfolios and Specifications
Table 110. Sandisk CSP Package eMMC Sales (Million Units), Revenue ($ Million), Price (US$/Unit) and Gross Margin (2021-2026)
Table 111. Sandisk Main Business
Table 112. Sandisk Latest Developments
Table 113. Micron Technology Basic Information, CSP Package eMMC Manufacturing Base, Sales Area and Its Competitors
Table 114. Micron Technology CSP Package eMMC Product Portfolios and Specifications
Table 115. Micron Technology CSP Package eMMC Sales (Million Units), Revenue ($ Million), Price (US$/Unit) and Gross Margin (2021-2026)
Table 116. Micron Technology Main Business
Table 117. Micron Technology Latest Developments
Table 118. Yangtze Memory Technologies Basic Information, CSP Package eMMC Manufacturing Base, Sales Area and Its Competitors
Table 119. Yangtze Memory Technologies CSP Package eMMC Product Portfolios and Specifications
Table 120. Yangtze Memory Technologies CSP Package eMMC Sales (Million Units), Revenue ($ Million), Price (US$/Unit) and Gross Margin (2021-2026)
Table 121. Yangtze Memory Technologies Main Business
Table 122. Yangtze Memory Technologies Latest Developments
Table 123. Longsys Basic Information, CSP Package eMMC Manufacturing Base, Sales Area and Its Competitors
Table 124. Longsys CSP Package eMMC Product Portfolios and Specifications

+357 96 030922
info@marketpublishers.com

Table 125. Longsys CSP Package eMMC Sales (Million Units), Revenue ($ Million), Price (US$/Unit) and Gross Margin (2021-2026)
Table 126. Longsys Main Business
Table 127. Longsys Latest Developments
Table 128. Kingston Technology Basic Information, CSP Package eMMC Manufacturing Base, Sales Area and Its Competitors
Table 129. Kingston Technology CSP Package eMMC Product Portfolios and Specifications
Table 130. Kingston Technology CSP Package eMMC Sales (Million Units), Revenue ($ Million), Price (US$/Unit) and Gross Margin (2021-2026)
Table 131. Kingston Technology Main Business
Table 132. Kingston Technology Latest Developments
Table 133. Silicon Motion Basic Information, CSP Package eMMC Manufacturing Base, Sales Area and Its Competitors
Table 134. Silicon Motion CSP Package eMMC Product Portfolios and Specifications
Table 135. Silicon Motion CSP Package eMMC Sales (Million Units), Revenue ($ Million), Price (US$/Unit) and Gross Margin (2021-2026)
Table 136. Silicon Motion Main Business
Table 137. Silicon Motion Latest Developments
Table 138. Macronix Basic Information, CSP Package eMMC Manufacturing Base, Sales Area and Its Competitors
Table 139. Macronix CSP Package eMMC Product Portfolios and Specifications
Table 140. Macronix CSP Package eMMC Sales (Million Units), Revenue ($ Million), Price (US$/Unit) and Gross Margin (2021-2026)
Table 141. Macronix Main Business
Table 142. Macronix Latest Developments
Table 143. BIWIN Basic Information, CSP Package eMMC Manufacturing Base, Sales Area and Its Competitors
Table 144. BIWIN CSP Package eMMC Product Portfolios and Specifications
Table 145. BIWIN CSP Package eMMC Sales (Million Units), Revenue ($ Million), Price (US$/Unit) and Gross Margin (2021-2026)
Table 146. BIWIN Main Business
Table 147. BIWIN Latest Developments
Table 148. Rayson Basic Information, CSP Package eMMC Manufacturing Base, Sales Area and Its Competitors
Table 149. Rayson CSP Package eMMC Product Portfolios and Specifications
Table 150. Rayson CSP Package eMMC Sales (Million Units), Revenue ($ Million), Price (US$/Unit) and Gross Margin (2021-2026)
Table 151. Rayson Main Business

+357 96 030922
info@marketpublishers.com

Table 152. Rayson Latest Developments
Table 153. HIKSEMI Basic Information, CSP Package eMMC Manufacturing Base, Sales Area and Its Competitors
Table 154. HIKSEMI CSP Package eMMC Product Portfolios and Specifications
Table 155. HIKSEMI CSP Package eMMC Sales (Million Units), Revenue ($ Million), Price (US$/Unit) and Gross Margin (2021-2026)
Table 156. HIKSEMI Main Business
Table 157. HIKSEMI Latest Developments
Table 158. ADATA Technology Basic Information, CSP Package eMMC Manufacturing Base, Sales Area and Its Competitors
Table 159. ADATA Technology CSP Package eMMC Product Portfolios and Specifications
Table 160. ADATA Technology CSP Package eMMC Sales (Million Units), Revenue ($ Million), Price (US$/Unit) and Gross Margin (2021-2026)
Table 161. ADATA Technology Main Business
Table 162. ADATA Technology Latest Developments
Table 163. Apacer Technology Basic Information, CSP Package eMMC Manufacturing Base, Sales Area and Its Competitors
Table 164. Apacer Technology CSP Package eMMC Product Portfolios and Specifications
Table 165. Apacer Technology CSP Package eMMC Sales (Million Units), Revenue ($ Million), Price (US$/Unit) and Gross Margin (2021-2026)
Table 166. Apacer Technology Main Business
Table 167. Apacer Technology Latest Developments
Table 168. Transcend Information Basic Information, CSP Package eMMC Manufacturing Base, Sales Area and Its Competitors
Table 169. Transcend Information CSP Package eMMC Product Portfolios and Specifications
Table 170. Transcend Information CSP Package eMMC Sales (Million Units), Revenue ($ Million), Price (US$/Unit) and Gross Margin (2021-2026)
Table 171. Transcend Information Main Business
Table 172. Transcend Information Latest Developments
Table 173. ATP Electronics Basic Information, CSP Package eMMC Manufacturing Base, Sales Area and Its Competitors
Table 174. ATP Electronics CSP Package eMMC Product Portfolios and Specifications
Table 175. ATP Electronics CSP Package eMMC Sales (Million Units), Revenue ($ Million), Price (US$/Unit) and Gross Margin (2021-2026)
Table 176. ATP Electronics Main Business
Table 177. ATP Electronics Latest Developments

+357 96 030922
info@marketpublishers.com

Table 178. Greenliant Basic Information, CSP Package eMMC Manufacturing Base, Sales Area and Its Competitors
Table 179. Greenliant CSP Package eMMC Product Portfolios and Specifications
Table 180. Greenliant CSP Package eMMC Sales (Million Units), Revenue ($ Million), Price (US$/Unit) and Gross Margin (2021-2026)
Table 181. Greenliant Main Business
Table 182. Greenliant Latest Developments
Table 183. Swissbit Basic Information, CSP Package eMMC Manufacturing Base, Sales Area and Its Competitors
Table 184. Swissbit CSP Package eMMC Product Portfolios and Specifications
Table 185. Swissbit CSP Package eMMC Sales (Million Units), Revenue ($ Million), Price (US$/Unit) and Gross Margin (2021-2026)
Table 186. Swissbit Main Business
Table 187. Swissbit Latest Developments
Table 188. HOSIN Global Electronics Basic Information, CSP Package eMMC Manufacturing Base, Sales Area and Its Competitors
Table 189. HOSIN Global Electronics CSP Package eMMC Product Portfolios and Specifications
Table 190. HOSIN Global Electronics CSP Package eMMC Sales (Million Units), Revenue ($ Million), Price (US$/Unit) and Gross Margin (2021-2026)
Table 191. HOSIN Global Electronics Main Business
Table 192. HOSIN Global Electronics Latest Developments
Table 193. SCY Basic Information, CSP Package eMMC Manufacturing Base, Sales Area and Its Competitors
Table 194. SCY CSP Package eMMC Product Portfolios and Specifications
Table 195. SCY CSP Package eMMC Sales (Million Units), Revenue ($ Million), Price (US$/Unit) and Gross Margin (2021-2026)
Table 196. SCY Main Business
Table 197. SCY Latest Developments
Table 198. KOWIN Technology Basic Information, CSP Package eMMC Manufacturing Base, Sales Area and Its Competitors
Table 199. KOWIN Technology CSP Package eMMC Product Portfolios and Specifications
Table 200. KOWIN Technology CSP Package eMMC Sales (Million Units), Revenue ($ Million), Price (US$/Unit) and Gross Margin (2021-2026)
Table 201. KOWIN Technology Main Business
Table 202. KOWIN Technology Latest Developments

+357 96 030922
info@marketpublishers.com

List Of Figures

LIST OF FIGURES

Figure 1. Picture of CSP Package eMMC
Figure 2. CSP Package eMMC Report Years Considered
Figure 3. Research Objectives
Figure 4. Research Methodology
Figure 5. Research Process and Data Source
Figure 6. Global CSP Package eMMC Sales Growth Rate 2021-2032 (Million Units)
Figure 7. Global CSP Package eMMC Revenue Growth Rate 2021-2032 ($ millions)
Figure 8. CSP Package eMMC Sales by Geographic Region (2021, 2025 & 2032) & ($ millions)
Figure 9. CSP Package eMMC Sales Market Share by Country/Region (2025)
Figure 10. CSP Package eMMC Sales Market Share by Country/Region (2021, 2025 & 2032)
Figure 11. Product Picture of 8GB and Below
Figure 12. Product Picture of 16GB
Figure 13. Product Picture of 32GB
Figure 14. Product Picture of 64GB
Figure 15. Product Picture of 128GB
Figure 16. Product Picture of 256GB and Above
Figure 17. Global CSP Package eMMC Sales Market Share by Type in 2026
Figure 18. Global CSP Package eMMC Revenue Market Share by Type (2021-2026)
Figure 19. Product Picture of Standard 153-ball BGA
Figure 20. Product Picture of Compact BGA
Figure 21. Product Picture of 100-ball BGA
Figure 22. Product Picture of Other
Figure 23. Global CSP Package eMMC Sales Market Share by Package Configuration in 2026
Figure 24. Global CSP Package eMMC Revenue Market Share by Package Configuration (2021-2026)
Figure 25. Product Picture of Commercial Grade
Figure 26. Product Picture of Industrial Grade
Figure 27. Product Picture of Automotive Grade
Figure 28. Global CSP Package eMMC Sales Market Share by Product Grade in 2026
Figure 29. Global CSP Package eMMC Revenue Market Share by Product Grade (2021-2026)
Figure 30. CSP Package eMMC Consumed in Smartphones & Tablets

+357 96 030922
info@marketpublishers.com

Figure 31. Global CSP Package eMMC Market: Smartphones & Tablets (2021-2026) & (Million Units)
Figure 32. CSP Package eMMC Consumed in Smart TV & Set-top Boxes
Figure 33. Global CSP Package eMMC Market: Smart TV & Set-top Boxes (2021-2026) & (Million Units)
Figure 34. CSP Package eMMC Consumed in Networking & Surveillance
Figure 35. Global CSP Package eMMC Market: Networking & Surveillance (2021-2026) & (Million Units)
Figure 36. CSP Package eMMC Consumed in Industrial & IoT
Figure 37. Global CSP Package eMMC Market: Industrial & IoT (2021-2026) & (Million Units)
Figure 38. CSP Package eMMC Consumed in Automotive Electronics
Figure 39. Global CSP Package eMMC Market: Automotive Electronics (2021-2026) & (Million Units)
Figure 40. CSP Package eMMC Consumed in Other
Figure 41. Global CSP Package eMMC Market: Other (2021-2026) & (Million Units)
Figure 42. Global CSP Package eMMC Sale Market Share by Application (2025)
Figure 43. Global CSP Package eMMC Revenue Market Share by Application in 2025
Figure 44. CSP Package eMMC Sales by Company in 2025 (Million Units)
Figure 45. Global CSP Package eMMC Sales Market Share by Company in 2025
Figure 46. CSP Package eMMC Revenue by Company in 2025 ($ millions)
Figure 47. Global CSP Package eMMC Revenue Market Share by Company in 2025
Figure 48. Global CSP Package eMMC Sales Market Share by Geographic Region (2021-2026)
Figure 49. Global CSP Package eMMC Revenue Market Share by Geographic Region in 2025
Figure 50. Americas CSP Package eMMC Sales 2021-2026 (Million Units)
Figure 51. Americas CSP Package eMMC Revenue 2021-2026 ($ millions)
Figure 52. APAC CSP Package eMMC Sales 2021-2026 (Million Units)
Figure 53. APAC CSP Package eMMC Revenue 2021-2026 ($ millions)
Figure 54. Europe CSP Package eMMC Sales 2021-2026 (Million Units)
Figure 55. Europe CSP Package eMMC Revenue 2021-2026 ($ millions)
Figure 56. Middle East & Africa CSP Package eMMC Sales 2021-2026 (Million Units)
Figure 57. Middle East & Africa CSP Package eMMC Revenue 2021-2026 ($ millions)
Figure 58. Americas CSP Package eMMC Sales Market Share by Country in 2025
Figure 59. Americas CSP Package eMMC Revenue Market Share by Country (2021-2026)
Figure 60. Americas CSP Package eMMC Sales Market Share by Type (2021-2026)
Figure 61. Americas CSP Package eMMC Sales Market Share by Application

+357 96 030922
info@marketpublishers.com

(2021-2026)
Figure 62. United States CSP Package eMMC Revenue Growth 2021-2026 ($ millions)
Figure 63. Canada CSP Package eMMC Revenue Growth 2021-2026 ($ millions)
Figure 64. Mexico CSP Package eMMC Revenue Growth 2021-2026 ($ millions)
Figure 65. Brazil CSP Package eMMC Revenue Growth 2021-2026 ($ millions)
Figure 66. APAC CSP Package eMMC Sales Market Share by Region in 2025
Figure 67. APAC CSP Package eMMC Revenue Market Share by Region (2021-2026)
Figure 68. APAC CSP Package eMMC Sales Market Share by Type (2021-2026)
Figure 69. APAC CSP Package eMMC Sales Market Share by Application (2021-2026)
Figure 70. China CSP Package eMMC Revenue Growth 2021-2026 ($ millions)
Figure 71. Japan CSP Package eMMC Revenue Growth 2021-2026 ($ millions)
Figure 72. South Korea CSP Package eMMC Revenue Growth 2021-2026 ($ millions)
Figure 73. Southeast Asia CSP Package eMMC Revenue Growth 2021-2026 ($ millions)
Figure 74. India CSP Package eMMC Revenue Growth 2021-2026 ($ millions)
Figure 75. Australia CSP Package eMMC Revenue Growth 2021-2026 ($ millions)
Figure 76. China Taiwan CSP Package eMMC Revenue Growth 2021-2026 ($ millions)
Figure 77. Europe CSP Package eMMC Sales Market Share by Country in 2025
Figure 78. Europe CSP Package eMMC Revenue Market Share by Country (2021-2026)
Figure 79. Europe CSP Package eMMC Sales Market Share by Type (2021-2026)
Figure 80. Europe CSP Package eMMC Sales Market Share by Application (2021-2026)
Figure 81. Germany CSP Package eMMC Revenue Growth 2021-2026 ($ millions)
Figure 82. France CSP Package eMMC Revenue Growth 2021-2026 ($ millions)
Figure 83. UK CSP Package eMMC Revenue Growth 2021-2026 ($ millions)
Figure 84. Italy CSP Package eMMC Revenue Growth 2021-2026 ($ millions)
Figure 85. Russia CSP Package eMMC Revenue Growth 2021-2026 ($ millions)
Figure 86. Middle East & Africa CSP Package eMMC Sales Market Share by Country (2021-2026)
Figure 87. Middle East & Africa CSP Package eMMC Sales Market Share by Type (2021-2026)
Figure 88. Middle East & Africa CSP Package eMMC Sales Market Share by Application (2021-2026)
Figure 89. Egypt CSP Package eMMC Revenue Growth 2021-2026 ($ millions)
Figure 90. South Africa CSP Package eMMC Revenue Growth 2021-2026 ($ millions)
Figure 91. Israel CSP Package eMMC Revenue Growth 2021-2026 ($ millions)
Figure 92. Turkey CSP Package eMMC Revenue Growth 2021-2026 ($ millions)
Figure 93. GCC Countries CSP Package eMMC Revenue Growth 2021-2026 ($

+357 96 030922
info@marketpublishers.com

millions)
Figure 94. Manufacturing Cost Structure Analysis of CSP Package eMMC in 2026
Figure 95. Manufacturing Process Analysis of CSP Package eMMC
Figure 96. Industry Chain Structure of CSP Package eMMC
Figure 97. Channels of Distribution
Figure 98. Global CSP Package eMMC Sales Market Forecast by Region (2027-2032)
Figure 99. Global CSP Package eMMC Revenue Market Share Forecast by Region (2027-2032)
Figure 100. Global CSP Package eMMC Sales Market Share Forecast by Type (2027-2032)
Figure 101. Global CSP Package eMMC Revenue Market Share Forecast by Type (2027-2032)
Figure 102. Global CSP Package eMMC Sales Market Share Forecast by Application (2027-2032)
Figure 103. Global CSP Package eMMC Revenue Market Share Forecast by Application (2027-2032)

+357 96 030922
info@marketpublishers.com

I would like to order

Product name: Global CSP Package eMMC Market Growth 2026-2032
Product link: https://marketpublishers.com/r/G8F033073353EN.html
Price: US$ 3,660.00 (Single User License / Electronic Delivery)

If you want to order Corporate License or Hard Copy, please, contact our Customer Service:
info@marketpublishers.com

Payment

To pay by Credit Card (Visa, MasterCard, American Express, PayPal), please, click button on product page https://marketpublishers.com/r/G8F033073353EN.html